

Image

2814



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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Stephen G. Kelly, et al.

Serial No.: 10/085,164

Filed: February 26, 2002

Art Unit: 2814

Examiner: Pham, Hoai V.

For: **ENCAPSULATED DIE PACKAGE WITH IMPROVED PARASITIC AND THERMAL PERFORMANCE**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**CERTIFICATE OF MAILING UNDER 37 C.F.R. 1.8**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on March 24, 2004.

Lisa Lynch

**RESPONSE TO RESTRICTION REQUIREMENT**

In response to the Office Action mailed February 26, 2004, Applicants hereby elect, without traverse, to prosecute in this application Species I, comprising Claims 1-44 drawn to a semiconductor device. Species II comprising Claims 45-50 drawn to a method of making a semiconductor device are cancelled pending the filing of divisional applications.

Respectfully submitted,

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March 24, 2004

Date